SCAS120A - MARCH 1990 - REVISED APRIL 1996

3OE

24

 Members of the Texas Instruments Widebus[™] Family 3-State Outputs Drive Bus Lines or Buffer 	54AC16244 WD PACKAGE 74AC16244 DGG OR DL PACKAGE (TOP VIEW)
Memory Address Registers	
 Flow-Through Architecture Optimizes PCB 	1Y1 🛛 2 47 🗍 1A1
Layout	1Y2 [3 46] 1A2
 Distributed V_{CC} and GND Configuration 	
Minimizes High-Speed Switching Noise	1Y3 [5 44] 1A3
● EPIC [™] (Enhanced-Performance Implanted	
CMOS) 1-μm Process	V _{CC} 7 42 V _{CC}
500-mA Typical Latch-Up Immunity at	2Y1 8 41 2A1
125°C	2Y2 9 40 2A2
Package Options Include Plastic 300-mil	GND 10 39 GND
Shrink Small-Outline (DL) and Thin Shrink	2Y3 1 11 38 2A3
Small-Outline (DGG) Packages Using 25-mil	2Y4 12 37 2A4
Center-to-Center Pin Spacings, and 380-mil	3Y1 13 36 3A1
Fine-Pitch Ceramic Flat (WD) Packages	3Y2 [14 35] 3A2
Using 25-mil Center-to-Center Pin Spacings	GND [15 34] GND
	3Y3 16 33 3A3
description	3Y4 17 32 3A4
•	
The 'AC16244 are 16-bit buffers/line drivers	4Y1 0 19 30 4A1
designed specifically to improve both the	4Y2 20 29 4A2
performance and density of 3-state memory	GND 21 28 GND
address drivers, clock drivers, and bus-oriented	4Y3 22 27 4A3
receivers and transmitters. They can be used as	4Y4 23 26 4 <u>A4</u>

The 74AC16244 is packaged in the TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54AC16244 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74AC16244 is characterized for operation from -40°C to 85°C.

	(each driver)							
	INPUTS OUTPUT							
L	OE	Α	Y					
Γ	L	Н	Н					
l	L	L	L					
	Н	Х	Z					

FUNCTION TABLE



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four 4-bit buffers, two 8-bit buffers, or one 16-bit

buffer. These devices provide true outputs and symmetrical active-low output-enable (OE) inputs. When \overline{OE} is low, the device passes noninverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the

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high-impedance state.



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54AC16244, 74AC16244 16-BIT BUFFERS/LINE DRIVERS WITH 3-STATE OUTPUTS SCAS120A – MARCH 1990 – REVISED APRIL 1996

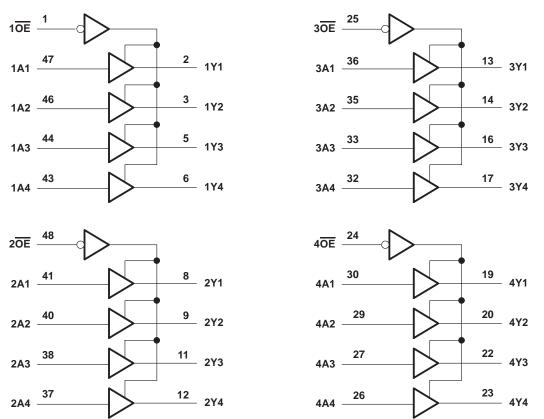
logic symbol[†]

	1,					
1 <mark>OE</mark>		EN1				
2 <mark>0E</mark>	48	EN2				
30E	25	EN3				
	24					
4OE		EN4		لے		
1A1	47		4		2	
	46		1	1 ▽	3	1Y1
1A2	44				5	1Y2
1A3	43				6	1Y3
1 A 4	41				8	1Y4
2A1		-	1	2 🗸		2Y1
2A2	40	_			9	2Y2
2A3	38				11	2Y3
	37				12	
2A4	36				13	2Y4
3A1	35		1	3 🗸	14	3Y1
3A2		-				3Y2
3A3	33	_			16	3Y3
3A4	32	_			17	3Y4
4A1	30				19	4Y1
	29	───	1	4 🗸	20	
4A2	27	_⊢			22	4Y2
4A3	26	_			23	4Y3
4A4						4Y4

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	\ldots —0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	$\dots -0.5$ V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0 or V _I > V _{CC})	±20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DGG package	0.85 W
DL package	1.2 W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.



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recommended operating conditions (see Note 3)

			54	AC1624	4	74	AC1624	4	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage (see Note 4)		3	5	5.5	3	5	5.5	V
		$V_{CC} = 3 V$	2.1			2.1			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V
		$V_{CC} = 5.5 V$	3.85			3.85			
		$V_{CC} = 3 V$			0.9			0.9	
VIL	Low-level input voltage	$V_{CC} = 4.5 V$		///	1.35			1.35	V
		$V_{CC} = 5.5 V$		3E	1.65			1.65	
VI	Input voltage		0	þ	VCC	0		VCC	V
VO	Output voltage		0	27	VCC	0		VCC	V
		$V_{CC} = 3 V$		5	-4			-4	
ЮН	High-level output current	$V_{CC} = 4.5 V$	(70	-24			-24	mA
		$V_{CC} = 5.5 V$	QQ	5	-24			-24	
		$V_{CC} = 3 V$			12			12	
IOL	Low-level output current	$V_{CC} = 4.5 V$			24			24	mA
		V _{CC} = 5.5 V			24			24	
$\Delta t/\Delta v$	Input transition rise or fall rate		0		10	0		10	ns/V
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTES: 3. Unused inputs should be tied to V_{CC} through a pullup resistor of approximately 5 kΩ or greater to prevent them from floating. 4. All V_{CC} and GND pins must be connected to the proper voltage supply.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER		, v	Т	_Δ = 25°C	;	54AC1	6244	74AC16244		UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
		3 V	2.9			2.9		2.9		
	I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
VOH	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48		V
	1011 - 24 mA	4.5 V	3.94			3.8		3.8		
	I _{OH} = -24 mA	5.5 V	4.94			4.8	ΞŊ	4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85	Иц	3.85		
		3 V			0.1		4 0.1		0.1	
	I _{OL} = -50 μA	4.5 V			0.1		0.1		0.1	
		5.5 V			0.1	C7	0.1		0.1	
VOL	I _{OL} = 12 mA	3 V			0.36	nc	0.44		0.44	V
	I _{OL} = 24 mA	4.5 V			0.36	10,	0.44		0.44	
	OL = 24 mA	5.5 V			0.36	Ч	0.44		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65		1.65	
lj	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
IOZ	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			±0.5		±5		±5	μΑ
ICC	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			8		80		80	μA
Ci	$V_{I} = V_{CC} \text{ or } GND$	5 V		4.5						
Co	$V_{I} = V_{CC} \text{ or } GND$	5 V		12						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Т	₄ = 25°C	;	54AC1	6244	74AC1	6244	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	А	v	2	7.1	9.4	2	10.8	2	10.8	ns
^t PHL	A	T	2.4	8.3	10.7	2.4	C 11.8	2.4	11.8	115
^t PZH	<u></u>	V	2.2	7.5	10	2.2	11.5	2.2	11.5	20
^t PZL	OE	T	2.9	10.4	13	2.9	14.6	2.9	14.6	ns
^t PHZ	05	V	4.1	6.8	8.4	4.1	9.1	4.1	9.1	
^t PLZ	ŌĒ		3.7	6.5	8.1	3.7	8.8	3.7	8.8	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

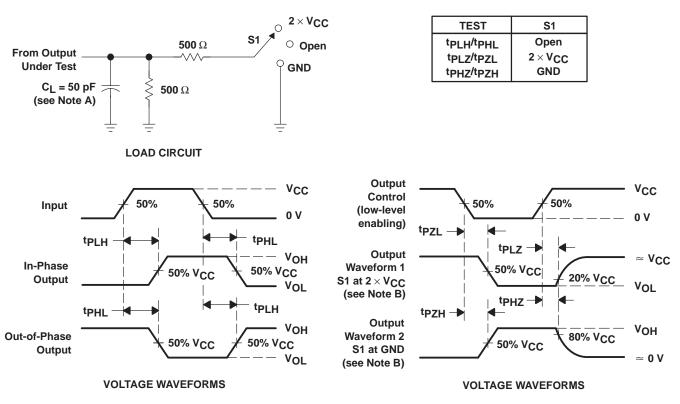
PARAMETER	FROM	то	Т	ן = 25°C	;	54AC1	6244	74AC1	6244	UNIT
FARAIWIETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	А	v	1.6	4.6	6.3	1.6	7.1	1.6	7.1	00
^t PHL	A	T	2	5.3	7	2	7.9	2	7.9	ns
^t PZH		V	1.7	4.8	6.7	1.7	7.5	1.7	7.5	
^t PZL	OE	T	2.2	6.1	8.1	2.2	9	2.2	9	ns
^t PHZ	OE	V	4	6.4	7.8	4	8.4	4	8.4	-
^t PLZ	UE		3.5	5.5	7.2	3.5	7.6	3.5	7.6	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CO	TYP	UNIT		
		Outputs enabled	C. 50 pF	f = 1 MHz	43	л Г
Cpd	Power dissipation capacitance per latch	Outputs disabled	CL = 50 pF,	f = 1 MHz	7	р⊢



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 3 ns, t_f = 3 ns. D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AC16244DGGR	ACTIVE	TSSOP	DGG	48	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
74AC16244DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
74AC16244DL	ACTIVE	SSOP	DL	48	25	Green (RoHS 8 no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AC16244DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS 8 no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AC16244DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

DL (R-PDSO-G**)



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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